

ASX RELEASE

26 September 2023

**NOTICE UNDER SECTION 708A OF THE CORPORATIONS ACT**

This notice is given by 4DS Memory Limited under section 708A(5)(e) of the *Corporations Act 2001* (Cth) (“Act”).

The Company has today issued 1,803,029 fully paid ordinary shares in the capital of the Company (“Issued Shares”), at an issue price of \$0.055 per Issued Share following the exercise of 1,803,029 unlisted 31 March 2026 options with an exercise price of \$0.055 each, 7,380,000 Issued Shares, at an issue price of \$0.052 per Issued Share following the exercise of 7,380,000 unlisted 22 January 2024 options with an exercise price of \$0.052 each and 4,000,000 Issued Shares, at an issue price of \$0.037 per Issued Share following the exercise of 4,000,000 unlisted 19 December 2027 options with an exercise price of \$0.037 each.

Pursuant to section 708A(5)(e) of the Act, the Issuer gives notice that:

- a) the Issued Shares were issued without disclosure to investors under Part 6D.2 of the Act;
- b) as at the date of this notice, the Issuer has complied with:
  - i. the provisions of Chapter 2M of the Act, as they apply to the Issuer; and
  - ii. section 674 of the Act; and
- c) as at the date of this notice, there is no information that is ‘excluded information’ within the meaning of sections 708A(7) and 708A(8) of the Act which is required to be disclosed by the Issuer.

Authorised for release by the 4DS Board.

**ENDS****Contact information**

**Investors:** David McAuliffe  
4DS Memory  
Interim Executive Chairman  
+61 408 994 313  
[david@4dsmemory.com](mailto:david@4dsmemory.com)

**About 4DS**

4DS Memory Limited (ASX: 4DS), with facilities located in Silicon Valley, is a semiconductor development company of non-volatile memory technology, pioneering Interface Switching ReRAM for next generation gigabyte storage in mobile and cloud. Established in 2007, 4DS owns a patented IP portfolio, comprising 34 USA patents granted which have been developed in-house to create high-density Storage Class Memory. 4DS has a joint development agreement with Western Digital subsidiary HGST, a global storage leader, which accelerates the evolution of 4DS’ technology. 4DS also collaborates with imec, a world-leading research and innovation hub in nanoelectronics and digital technologies. The combination of imec’s widely acclaimed leadership in microchip technology and profound software and information and communication technology expertise makes them unique.

For more information, please visit [www.4dsmemory.com](http://www.4dsmemory.com).